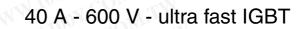


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STGW40NC60WD



Features

- Low C_{RES} / C_{IES} ratio (no cross conduction susceptibility)
- IGBT co-packaged with ultra fast free-wheeling diode
- High frequency operation

Applications

- High frequency inverters, UPS
- Motor drivers
- HF, SMPS and PFC in both hard switch and resonant topologies
- Welding
- Induction heating

Description

This IGBT utilizes the advanced PowerMESH[™] process resulting in an excellent trade-off between switching performance and low on-state behavior.

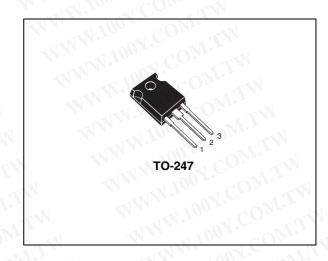
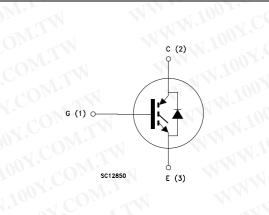


Figure 1. Internal schematic diagram



Order code	Marking	Package	Packaging	N
STGW40NC60WD	GW40NC60WD	TO-247	Tube	

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2	Electrical characteristics	
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3	Test circuit	8
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5	Revision history	WT.

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Electrical ratings

Elect	trical ratings	WWW.1002.CON.TW
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Table 2	Absolute maximu	Im ratings

Symbol	Absolute maximum ratings Parameter	Value	Uni
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at 25 °C	070	A
I _C ⁽¹⁾	Collector current (continuous) at 100 °C	40	A
I _{CL} ⁽²⁾	Turn-off latching current	230	Α
I _{CP} ⁽³⁾	Pulsed collector current	230	A
V _{GE}	Gate-emitter voltage	±20	v
I _E	Diode RMS forward current at T _C =25 °C	30	A
I _{FSM}	Surge non repetitive forward current (tp=10 ms sinusoidal)	120	Α
P _{TOT}	Total dissipation at $T_{C} = 25 \text{ °C}$	250	W
Тj	Operating junction temperature	– 55 to 150	O°C
Т _ј . Calculate ^I c ^{(T} c ⁾ = _{Ятн} . . Vclamp =			

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$$I_{C}(T_{C}) = \frac{I_{JMAX} - I_{C}}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{C}, I_{C})}$$

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able 3. Symbol	Thermal resistance Parameter	Value	
R _{thj-case}	Thermal resistance junction-case max (IGBT)	0.5	°C/
R _{thj-case}	Thermal resistance junction-case max (diode)	1.5	°C/
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/\



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W.100X.COM.TW **Electrical characteristics**

2	Electr	ical characterist	tics				
	(T _{CASE} =2 Table 4.	5 °C unless otherwise spec Static	ified)				
	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	V _{(BR)CES}	Collector-emitter breakdown voltage ($V_{GE} = 0$)	I _C = 1 mA	600	LM		v
	V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _C =125 °C	col	2.1 1.9	2.5	V V
	V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 250µA	3.75	122	5.75	V
	ICES	Collector-emitter cut-off current (V _{GE} = 0)	V _{GE} = 600 V V _{GE} = 600 V, T _C =125 °C	04.0	CO2 2024	500 5	μA mA
	I _{GES}	Gate-emitter cut-off current (V _{CE} = 0)	V _{GE} = ± 20 V	1002	N.C	±100	nA
	9 _{fs}	Forward transconductance	V _{CE} = 15 V _, I _C = 30 A		20		S
	Table 5.	Dynamic	OM. WY	N.Y	100%	N.CC	M
	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit

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Table 4 Ctatio

Table 5.	Dynamic
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C _{ies}	Input capacitance	CONTRA		2900		p
C _{oes}	Output capacitance Reverse transfer	$V_{CE} = 25 \text{ V}, \text{ f} = 1 \text{ MHz}, \text{ V}_{GE} = 0$	W.	298	100	р р
C _{res}	capacitance	TON TON COMPLETEN		59	N.10	р.
Qg	Total gate charge	$V_{CE} = 390 \text{ V}, I_{C} = 30 \text{ A},$		126	N.	nC
Q _{ge}	Gate-emitter charge	V _{GE} = 15 V		16		nC
Q _{gc}	Gate-collector charge	(see Figure 18)		46	NN	nC

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ (see Figure 17)	1.TV M.T	33 12 2600		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay timE Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_C = 125 \text{ °C}$ <i>(see Figure 17)</i>	COV OW	32 14 2300		ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V}$ <i>(see Figure 17)</i>	1.0 07.0	26 168 36	1.14	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A},$ $R_{GE}=10 \Omega, V_{GE} = 15 \text{ V},$ $T_C=125 \text{ °C} (see Figure 17)$	100	54 213 67	ON.	ns ns ns

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Switching on/off (inductive load) Table 6.

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{\rm CC}$ = 390 V, I _C = 30 A	A	302	N.	μJ
E _{off} ⁽²⁾	Turn-off switching losses	R _G = 10 Ω, V _{GE} = 15 V		349	00	μJ
E _{off} ⁽²⁾ E _{ts}	Total switching losses	(see Figure 17)	W	651	100	μJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390$ V, I _C = 30 A R _G = 10 Ω, V _{GE} = 15 V, T _C = 125 °C (see Figure 17)	4	553 750 1303	N.10	μJ μJ μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2 Eon include diode recovery energy. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

2. Turn-off losses include also the tail of the collector current WW.100Y.COM

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Symbol	Parameter	Test conditions	Min	Тур.	Max	Uni
V _F	Forward on-voltage	I _F = 30 A I _F = 30 A, T _C = 125 °C	1.17	2.4 1.8		V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 30 A, V _R = 50 V, di/dt =100 A/μs (<i>see Figure 20</i>)	DW.	45 56 2.55		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 30 \text{ A}, V_R = 50 \text{ V},$ $T_C = 125 \text{ °C},$ di/dt =100 A/µs (see Figure 20)		100 290 5.8	N N N	ns nC A

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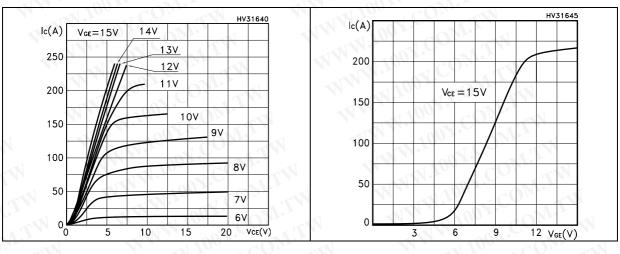
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Electrical characteristics (curves) 2.1

Output characteristics Figure 2.

Figure 3. Transfer characteristics





Vce=15V

T」=−50°C

150°C

15

 $g_{fS}(S)$

18

15

12

9

3L ()



Figure 5. Collector-emitter on voltage vs

temperature

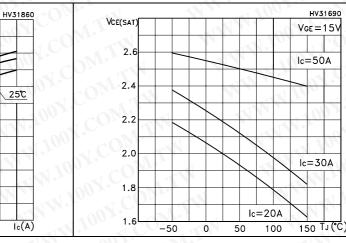
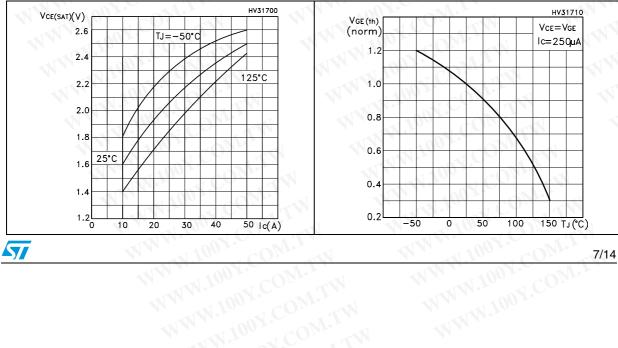


Figure 6. Collector-emitter on voltage vs collector current

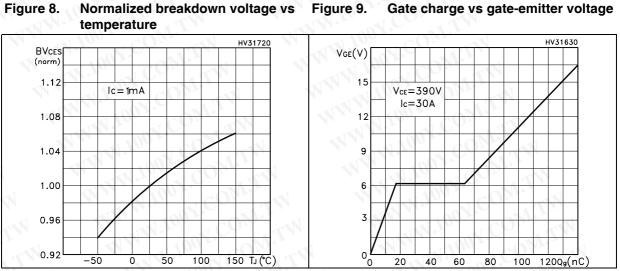
Figure 7. Normalized gate threshold vs temperature

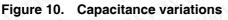


Electrical characteristics

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C(pF)

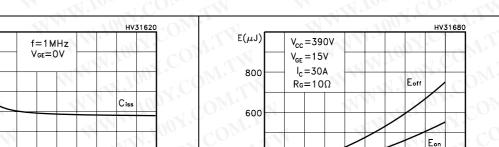
4000

3000

2000

1000

Crss



400

200

0 0 10 20 30 40 Vce(V) 50 100 T_J(°C) 25 75

Coss

Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current

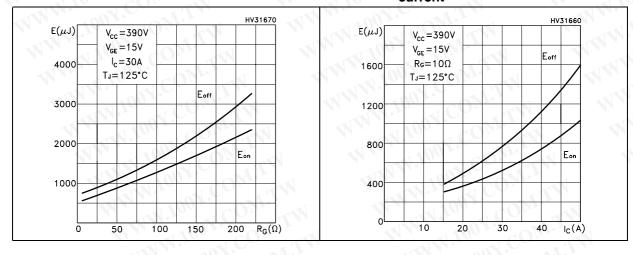


Figure 9. Gate charge vs gate-emitter voltage

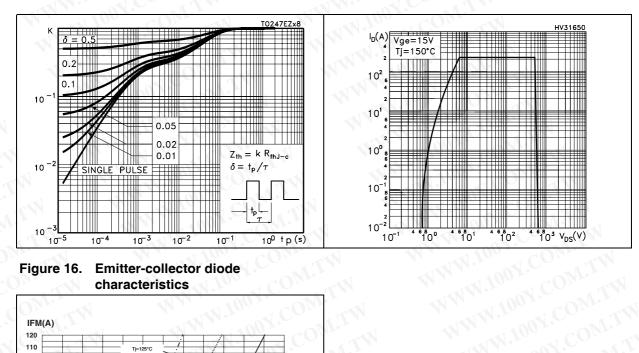
Figure 11. Switching losses vs temperature

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Figure 14. Thermal impedance

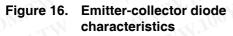
Figure 15. Turn-off SOA

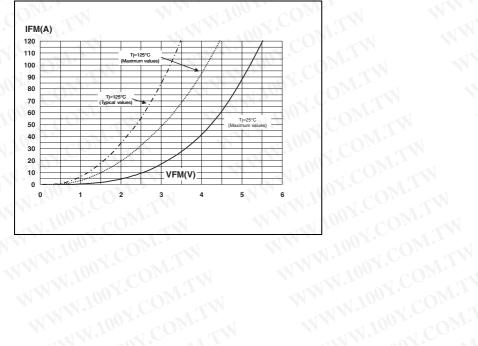
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25% |RRM

VF

SC20030 IGBTs

°cc

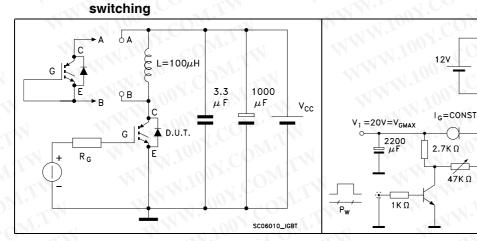
1KΩ

۷_G

SC09910

Test circuit 3

Figure 17. Test circuit for inductive load



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Figure 18. Gate charge test circuit

 \frown 47ΚΩ

dV/dt

47K Ω

100nF

1ΚΩ

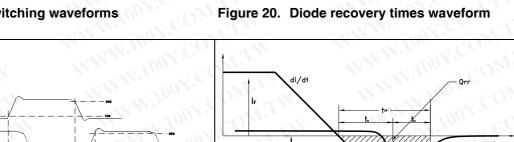


Figure 19. Switching waveforms



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Package mechanical data

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In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com WWW.100Y.COM

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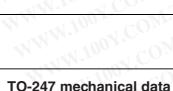
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N. P. ONY.C	TO-24	47 mechanical data	
N. Jonal	CORTEN	W.W.W. CO.	THE STATE
Dim.	CONTRACT	mm.	Dive.
100	Min.	Тур	Max.
A	4.85	YOU.	5.15
A1	2.20	W. W. Local	2.60
b	1.0	W. W.100	1.40
b1	2.0	WW 100	2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85	W W	20.15
E	15.45	W W	15.75
e	1 1001. ON	5.45	1001.001.1
L	14.20	N. W	14.80
L1	3.70	1.TM	4.30
L2	W.IO. CC	18.50	W.Io. COn
øP	3.55	ON. WY	3.65
øR	4.50	ON. I	5.50
S	ANN ON	5.50	ANN. N.

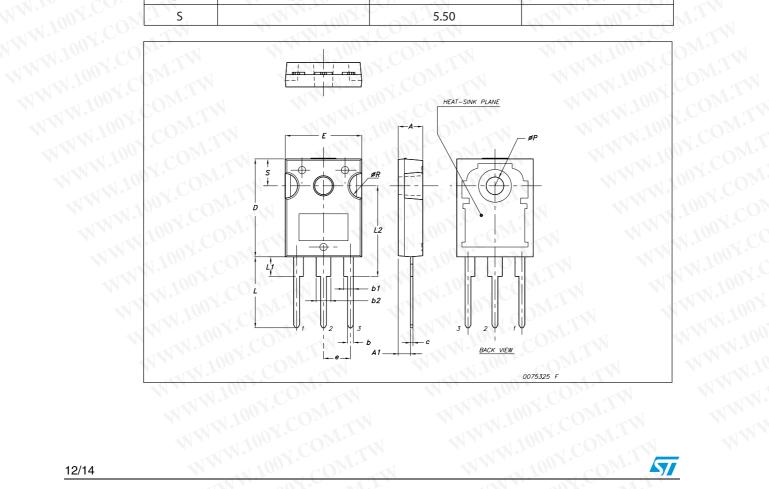


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Revision history

Revisi	ion histor	y	
Table 9.	Document re	evision history	
			Revision history Table 9. Document revision history

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Date	Revision	Changes
8-Jun-2006	1.1	First release
8-Nov-2006	2	Modified <i>Dynamic</i>
01-Feb-2008	3	Updated Table 7
09-Jul-2008	4	Added new feature

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